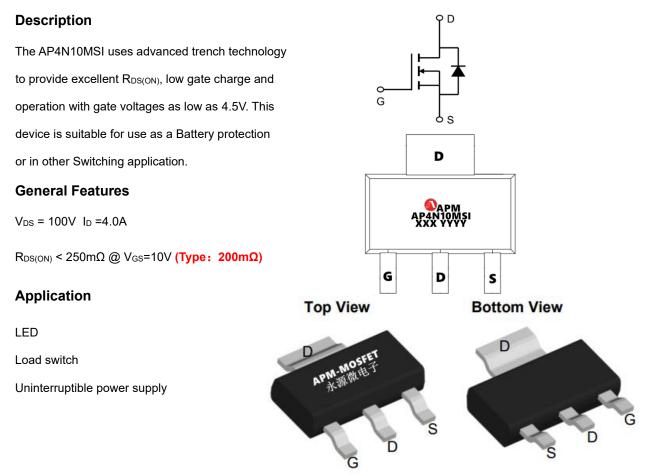


100V N-Channel Enhancement Mode MOSFET



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP4N10MSI	SOT223-3L	AP4N10MSI XXX YYYY	3000

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	100	V
Vgs	Gate-Source Voltage	±20	V
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	4.0	A
I _D @T _A =100°C	Continuous Drain Current, V _{GS} @ 10V ¹	2.0	A
Ідм	Pulsed Drain Current ²	8	A
PD@TA=25°C	Total Power Dissipation ³	3.75	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _{0JA}	Thermal Resistance Junction-ambient ¹	85	°C/W
R _θ JC	Thermal Resistance Junction-Case ¹	30	°C/W



100V N-Channel Enhancement Mode MOSFET

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	VGS = 0 V, ID = 250µA	100	111	-	V
IGSS	Gate Leakage Current	VGS = ±20V, VDS = 0V	-	-	±100	nA
IDSS	Drain Cut-off Current	VDS = 100V, VGS = 0V	-	-	1	μA
VGS(th)	Gate Threshold Voltage	VGS = VDS, ID = 250µA	1.2	1.6	2.5	V
RDS(on)	Drain-Source on-state Resistance3	VGS = 10V, ID = 2A	-	200	250	
		VGS = 4.5V, ID = 1.5A	-	220	280	mΩ
Ciss	Input Capacitance		-	440	-	pF
Coss	Output Capacitance	VGS = 0V, VDS = 50V, f = 1MHz	-	14	-	pF
Crss	Reverse Transfer Capacitance		-	10	-	pF
Qg	Total gate charge		-	5.3	-	nC
Qgs	Gate-source charge	VGS = 10V, VDS = 50V, ID = 2A	-	1.4	-	nC
Qgd	Gate-drain charge		-	1.8	-	nC
td(on)	Turn-on Time		-	14	-	ns
tf	Rise time	VGS = 10V, VDD = 50V, RG =	-	54	-	ns
td(off)	Turn-off Time	1Ω, ID = 2A	-	18	-	ns
tf	Fall time		-	11	-	ns
VSD	Body Diode Voltage3		-	-	1.2	V
IS	Continuous Source Current	IS= 1A, VGS = 0V	-	-	2	А

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

 $3\,{\scriptstyle \sim}\,$ The power dissipation is limited by $150\,{\rm ^{\circ}C}$ junction temperature

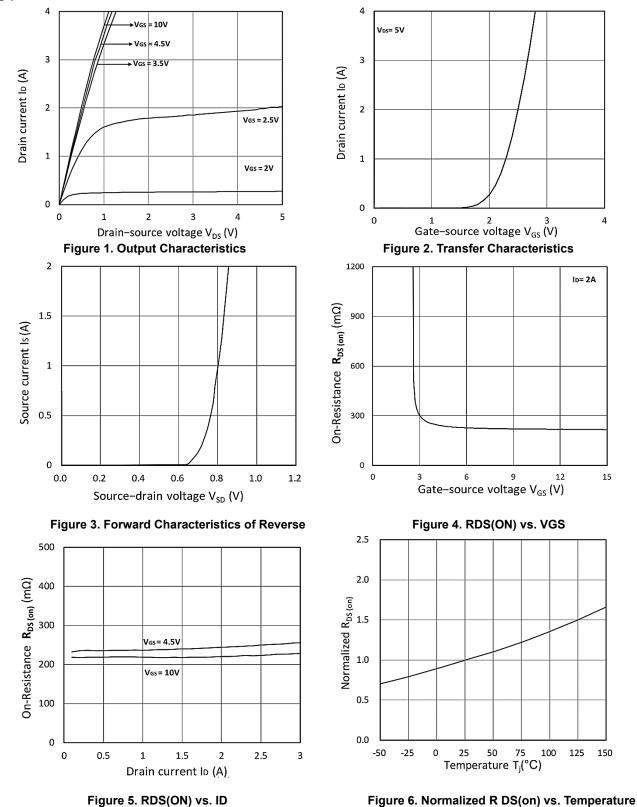
4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

N



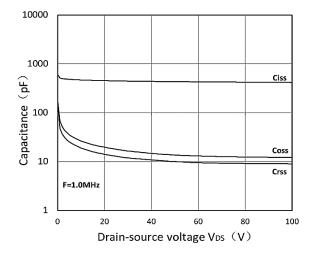
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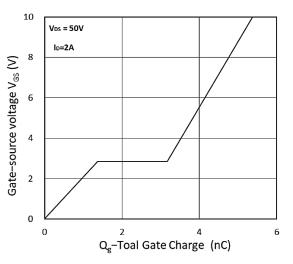
Typical Characteristics





100V N-Channel Enhancement Mode MOSFET





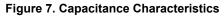


Figure 8. Gate Charge Characteristics

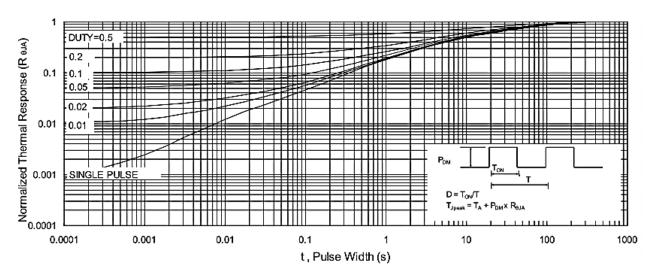


Fig.9 Normalized Maximum Transient Thermal Impedance

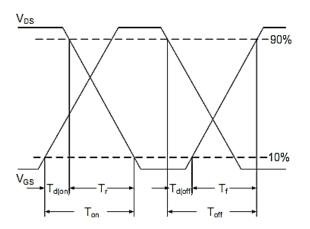


Fig.10 Switching Time Waveform

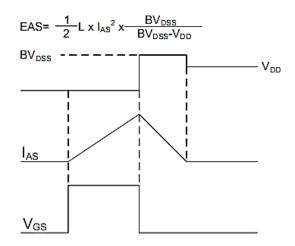
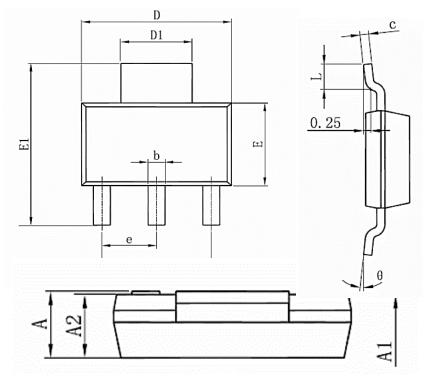


Fig.11 Unclamped Inductive Switching Waveform



100V N-Channel Enhancement Mode MOSFET

Package Mechanical Data:SOT223-3L



Cumple of	Dimensions In Millimeters		
Symbol	Min.	Max.	
A	1.52	1.8	
A1	0.000	0.100	
A2	1.5	1.7	
b	0.66	0.82	
С	0.25	0.35	
D	6.2	6.4	
D1	2.9	3.1	
E	3.3	3.7	
E1	6.83	7.07	
e	2.300(BSC)		
e1	4.500	4.700	
L	0.900	1.15	
θ	0°	10°	



100V N-Channel Enhancement Mode MOSFET

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Edition	Date	Change
REV1.0	2023/10/1	Initial release

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